

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	1924	257/773.ccls.	US-PGPUB; USPAT; USOCR
2	BRS	L2	1530	257/786.ccls.	US-PGPUB; USPAT; USOCR
3	BRS	L3	2096	257/774.ccls.	US-PGPUB; USPAT; USOCR
4	BRS	L4	2429	257/778.ccls.	US-PGPUB; USPAT; USOCR
5	BRS	L5	1107	257/750.ccls.	US-PGPUB; USPAT; USOCR
6	BRS	L11	1758	257/737.ccls.	US-PGPUB; USPAT; USOCR
7	BRS	L13	3246	(chip adj scale adj package)	US-PGPUB; USPAT; USOCR
8	BRS	L14	1165	L13 and pad and (insulating or protection) and first and second and (opening or via)	US-PGPUB; USPAT; USOCR

	Type	L #	Hits	Search Text	DBs
9	BRS	L15	120	L14 and (UBM or PLM or BLM)	US-PGPUB; USPAT; USOCR
10	BRS	L10	4	L5 and pad and (UBM or PLM or BLM) and (insulating or protection) and first and second and (opening or via)	US-PGPUB; USPAT; USOCR
11	BRS	L8	11	L3 and pad and (UBM or PLM or BLM) and (insulating or protection) and first and second and (opening or via)	US-PGPUB; USPAT; USOCR
12	BRS	L6	12	L1 and pad and (UBM or PLM or BLM) and (insulating or protection) and first and second and (opening or via)	US-PGPUB; USPAT; USOCR
13	BRS	L7	12	L2 and pad and (UBM or PLM or BLM) and (insulating or protection) and first and second and (opening or via)	US-PGPUB; USPAT; USOCR
14	BRS	L9	38	L4 and pad and (UBM or PLM or BLM) and (insulating or protection) and first and second and (opening or via)	US-PGPUB; USPAT; USOCR
15	BRS	L12	47	L11 and pad and (UBM or PLM or BLM) and (insulating or protection) and first and second and (opening or via)	US-PGPUB; USPAT; USOCR

	Type	L #	Hits	Search Text	DBs
23	BRS	L23	356	257/786.ccls.	EPO; JPO; DERWEN T; IBM_TDB
24	BRS	L24	235	257/737.ccls.	EPO; JPO; DERWEN T; IBM_TDB
25	BRS	L25	221	257/774.ccls.	EPO; JPO; DERWEN T; IBM_TDB
26	BRS	L26	99	257/760.ccls.	EPO; JPO; DERWEN T; IBM_TDB

	Type	L #	Hits	Search Text	DBs
16	BRS	L16	1355	(UBM or PLM or BLM) and (insulating or protection) and first and second and (opening or via)	US-PGPUB; USPAT; USOCR
17	BRS	L17	469	L16 and pad and bump	US-PGPUB; USPAT; USOCR
18	BRS	L18	357	L17 and plurality	US-PGPUB; USPAT; USOCR
19	BRS	L19	60	L18 and inorganic and (polymer or polyimide)	US-PGPUB; USPAT; USOCR
20	BRS	L20	690	257/760.ccls.	US-PGPUB; USPAT; USOCR
21	BRS	L21	1	L20 and pad and (UBM or PLM or BLM) and (insulating or protection) and first and second and (opening or via)	US-PGPUB; USPAT; USOCR
22	BRS	L22	449	257/773.ccls.	EPO; JPO; DERWEN T; IBM_TDB

	Type	L #	Hits	Search Text	DBs
6	BRS	L6	2105	((insulating or passivation) and (inorganic or oxide or nitride) and (opening or window or via) and (metal or metallization or pad)).clm.	US-PGPU B
7	BRS	L7	1965	L6 and first and second	US-PGPU B
8	BRS	L8	331	L7 and (seed or buffer) and (stack or plurality)	US-PGPU B
9	BRS	L9	622	((insulating or passivation) and (inorganic or oxide or nitride) and (opening or window or via) and (metal or metallization or pad) and (organic or polymer)).clm.	US-PGPU B
10	BRS	L10	107	L9 and (seed or buffer) and (stack or plurality)	US-PGPU B

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	1924	257/773.ccls.	US-PGPU B; USPA T; USO CR
2	BRS	L2	360	L1 and pad and (insulating or passivation) and first and second and (opening or window or via)	US-PGPU B; USPA T; USO CR
3	BRS	L3	3246	(chip adj scale adj package)	US-PGPU B; USPA T; USO CR
4	BRS	L4	1115	L3 and pad and (insulating or passivation) and first and second and (opening or window or via)	US-PGPU B; USPA T; USO CR
5	BRS	L5	161	L4 and (UBM or PLM or BLM)	US-PGPU B; USPA T; USO CR